Design and Modeling of an Integrated Octagonal Shaped Inductor with Substrate Silicon in a Buck Converter

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ABSTRACT
The paper discusses the design and modeling of an integrate octagonal shaped inductor with silicon substrate. A validated equivalent electrical model of the integrated octagonal shaped spiral inductor was developed. The model was used to analyze and evaluate the quality factor and the inductance of the inductor structure proposed under different physical parameters setting. These include the number of turns, spacing between turns and the inner diameter. The simulation results show that an appropriate selection of physical parameters can achieve an enhanced quality factor and improved inductance. PSIM simulator was used for the implementation of the integrated inductor in a micro buck converter. The simulation results demonstrate that our proposals are very promising approaches for the monolithic integration of DC-DC converters.

1. INTRODUCTION
Modern portable electronics devices, such as cell phones, GPS (Global Positioning System) and PDA (Personal Digital Assistant), are getting smaller in size and embedding more and more features at the same time. However, these latter demands more power supply. Hence, to meet this energy demand smaller, smarter and more efficient DC-DC switching inductive converters are needed.

Switching inductive converters use inductors to transfer power from the battery to the load, which might lead to 100% efficiency in an ideal case. Thence it of these devices is that they exhibit an excellent transient performance, such as line/load regulations, without any efficiency deterioration [1-3]. These switching inductive converters have gained more interest and are considered most appropriate DC-DC converters when the required power density is high and the efficiency is critical.

In modern portable electronics, such as cell phones, the power-hungry subsystems are always regulated by switching inductive converters [4-7]. Following the success in their manufacturing, intensive researches have been conducted in the modeling of spiral inductors on silicon [8]. Most research approaches opted for the use of compact circuit models [9]. These types of models are used in the synthesis and design of spiral inductors in silicon [10].

The main objective of this paper is to reduce the influence of magnetically induced losses in the inner turns of the spiral where the magnetic field reaches its maximum [11]. This can be achieved by reducing the line width toward the center of the spiral. This approach will lead to minimization of the coils inductor series resistance. Research results reported using this approach is very promising. The successful research results
reported encouraged research for deeper studies on the device performance limitations, which will ultimately contribute to the design of improved and efficient devices.

In this paper, octagonal shaped planar spiral inductor is proposed. A simplified electrical circuit model of the inductor is developed. The relationship between technological parameters and their effect on the geometrical characteristic of the inductor are investigated. The technological parameters include the number of turns, inner diameter, width and space of the inductor. Moreover, the structure is analyzed and evaluated under different technological parameters to achieve an enhanced quality factor. This work is completed by an application of the proposed integrated inductor.

2. DESIGN AND MODELING OF SPIRAL INDUCTOR

For the spiral structure, there are several topological models as shown in Figure 1 [12]: In this study octagonal, geometry is selected [13-15]. Figure 2 shows a typical implementation of an integrated octagonal spiral inductor where the important physical dimensions of the spiral inductor are identified. These include inner diameter (din), outer diameter (dout), space between turns (s) and width of the metal trace (w). Table 1 indicates the specifications and the design results of the selected octagonal shape inductor.

![Figure 1. Different inductor geometries (a) square, (b) hexagonal, (c) octagonal, (d) circular](image)

![Figure 2. Typical layout of an integrated octagonal spiral inductor](image)

<table>
<thead>
<tr>
<th>Geometric parameters</th>
<th>Symbol</th>
<th>Value</th>
</tr>
</thead>
<tbody>
<tr>
<td>Number of turns</td>
<td>N</td>
<td>2</td>
</tr>
<tr>
<td>Spacing between turns</td>
<td>s</td>
<td>8 µm</td>
</tr>
<tr>
<td>Width of conductor</td>
<td>W</td>
<td>26 µm</td>
</tr>
<tr>
<td>Thickness of conductor</td>
<td>T</td>
<td>1,5 µm</td>
</tr>
<tr>
<td>Inner diameter</td>
<td>din</td>
<td>70 µm</td>
</tr>
<tr>
<td>Outer diameter</td>
<td>dout</td>
<td>140 µm</td>
</tr>
</tbody>
</table>

In order to take into account the losses over a range of frequencies, the PI circuit model of spiral inductors on silicon depicted in Figure 3 is used. More details about the PI model used can be found in references [16-19].

![Figure 3. PI circuit equivalent model of a spiral inductor](image)
The different components of the PI circuit model shown in Figure 3 are defined as follows:

- $L_s$ is the inductance of the spiral inductor
- $R_s$ is the resistance of the metal trace.
- $C_s$ is the capacitance of the direct coupling due to the overlap between the spiral and the underpass.
- $C_{ox}$ is the oxide capacitance which represents the capacitive coupling between the inductor and the substrate through the oxide layer.
- The resistance and capacitance of the substrate, referred to ground, are represented by ($R_{si}$) and ($C_{si}$), respectively.

It is worth to mention that characteristics of each component constituting the equivalent circuit model are strongly dependent on the inductor shape as well as the technological parameters of the CMOS process used.

Several mathematical expressions are available in published literature to compute the value of inductance. In this studies the following Monomial expression [20]

$$L_s = \beta \cdot d_{out}^{\alpha_1} \cdot w^{\alpha_2} \cdot d_{avg}^{\alpha_3} \cdot n^{\alpha_4} \cdot s^{\alpha_5}$$  \hspace{1cm} (1)

The monomial expression is selected because of its accuracy and simplicity to compute the inductor value. It can also be used for optimal design of spiral inductors geometric design [21].

Where $\beta$ is a layout dependent constant, $d_{avg} = (d_{out} + d_{in})/2$ is the average diameter of the spiral layout, $n$= number of spiral turns, $\alpha_i$ where $i$ = 1 to 5 are the coefficients and are layout dependent. For octagonal layout $\alpha_1 = -1.21$, $\alpha_2 = -0.163$, $\alpha_3 = 2.43$, $\alpha_4 = 1.75$, $\alpha_5 = -0.049$ and $\beta = 1.33 \times 10^{-3}$.

The series resistance $R_s$, can be approximated by the following expression [22]:

$$R_s = \frac{\rho}{\omega t}$$  \hspace{1cm} (2)

Where $\rho$ and $t$ are the metal resistivity and thickness, respectively. The metal length $l$, is calculated using the following expression [23-27]:

$$l = [d_{out} - (n - 1) s - n w] - s$$  \hspace{1cm} (3)

Where $d_{out}$, $n$, $s$ and $w$ are already defined above.

The other components of the equivalent circuit are computed using the following expressions:

$$C_s = \frac{n w^2 \varepsilon_{ox}}{t_{ox}}$$ \hspace{1cm} (4)

$$C_{ox} = \frac{w l \varepsilon_{ox}}{2 \ t_{ox}}$$ \hspace{1cm} (5)

$$C_{si} = \frac{1}{2} l w C_{sub}$$ \hspace{1cm} (6)

$$R_{si} = \frac{2}{l w G_{sub}}$$ \hspace{1cm} (7)

Where, $t_{ox}$ is oxide thickness between the spirals and substrate, $C_{sub}$ is substrate capacitance per unit area, $G_{sub}$ is substrate conductance per unit area and $\varepsilon_{ox}$ is the permittivity of oxide. The other parameters are as defined above. Table 2 indicates the nominal values of the electrical parameters of the integrated inductor used in the simulation.

<table>
<thead>
<tr>
<th>Table 2. Electricals parameters of the integrated inductor</th>
</tr>
</thead>
<tbody>
<tr>
<td><strong>Electricals Parameters</strong></td>
</tr>
<tr>
<td>---------------------------</td>
</tr>
<tr>
<td>$L_s$</td>
</tr>
<tr>
<td>$R_s$</td>
</tr>
<tr>
<td>$C_s$</td>
</tr>
<tr>
<td>$C_{ox}$</td>
</tr>
<tr>
<td>$R_{si}$</td>
</tr>
<tr>
<td>$C_{si}$</td>
</tr>
</tbody>
</table>

The simulation results are presented using the S-parameters form. The S parameters are then converted into Y parameters using following equations (8), (9), and (10) [28]:

*Design and Modeling of an Integrated Octagonal Shaped Inductor... (A Namoune, et al)*
\[ Y_{11} = \frac{(1+S_{11})(1+S_{22})+S_{12}S_{21}}{(1+S_{11})(1+S_{22})-S_{12}S_{21}} \]  
\[ Y_{12} = \frac{-2S_{12}}{(1+S_{11})(1+S_{22})-S_{12}S_{21}} \]  
\[ Y_{22} = \frac{(1+S_{11})(1+S_{22})+S_{12}S_{21}}{(1+S_{11})(1+S_{22})-S_{12}S_{21}} \]

The electrical parameters \( L \) and \( Q \) are computed using equations (11) and (12) which are derived using the inductor equivalent circuit theory.

\[ L = \left[ \frac{1}{Y_{11}} \right] / 2 \pi f \]  \hspace{1cm} (11)
\[ Q = \frac{\text{Im}(1/Y_{11})}{\text{Re}(1/Y_{11})} \]  \hspace{1cm} (12)

Where \( f \) represents the frequency. \( L \), \( Q \), \( Y \) represent the inductance, quality factor and admittance respectively. The symbols \( \text{Im} \) and \( \text{Re} \) represent the imaginary part and real part respectively.

3. SIMULATION RESULT

The performance evaluation of the spiral inductor proposed is performed using MATLAB simulation software, which allows more flexibility during the design process. In addition, the effect of spiral inductor geometry variations is more easily analyzed using MATLAB.

3.1. Effect of Design Parameters on Quality Factor and Inductance

a. Optimization of Width and Space of the Inductor

The four inductor structures are investigated under different values of width \( (w) \) and space \( (s) \) while keeping their sum the same and equal to 35 µm. Their respective width and space sums are 13+22 µm, 19+16 µm, 25+10 µm, and 29+6 µm. Where the first term represents the width \( (w) \) and the second term represents the space \( (s) \). The number of coils of the four inductors is fixed at 2 and their inner diameter is 70 µm. Figure 4 shows the top view of the four structures proposed.

![Figure 4](image)

Figure 4. The top view of inductors with \( (w+s) \) as (a) 13+22 µm, (b) 19+16 µm, (c) 25+10 µm, (d) 29+6 µm.

![Figure 5](image)

Figure 5. Effect on inductance value (a), quality factor (b) for different designs of spiral inductor
Figure 5 shows the variation of the inductance and quality factor $Q$ versus frequency of the four structures for different values of width and space. As shown in Figure 5(a) up to 5 MHz, the inductances of the four structures are not affected by the width ($w$) and space ($s$) changes and exhibit almost the same variation. However, above 5 MHz, the inductance curves appear different because of the different parasitic capacitances, which are dependent on the width and space. The results of the quality factors obtained are shown in Figure 5(b). As shown in Figure 5(b), the quality factors curves exhibit maximum values at frequency about 5 MHz for different values of width and space. The largest quality factor $Q$ is obtained with the structure having 25 $\mu$m line width and 10 $\mu$m line space about the frequency of 5 MHz.

b. Effect of Number Turns

The simulation results of the inductance and quality factor variation versus frequency for three different values of number of turns (i.e. 2, 3 and 4) are shown in Figure 6. As illustrated in Figure 6(a), up to around 5 MHz, the inductance increases with frequency and the spiral with the highest number of turns exhibit the highest inductance. However, from Figure 6(a), it can be deduced that the inductance value does not increase linearly with the number of turns, as the area of the inner diameter (loop area) is smaller compared to the outer diameter. The self-resonance frequency decreases significantly for each new winding added because of the increased capacitive coupling between the turns and the increased capacitive coupling to the substrate. Figure 6(b) shows variation of the maximum quality factor versus frequency for different values of number of turns. As shown in Figure 6(b) the maximum quality factor decreases with the increasing number of turns. This is due to increased metal losses.

![Figure 6](image1.png)

Figure 6. Effect on inductance (a), quality factor (b) value for different number of turns.

![Figure 7](image2.png)

Figure 7. Effect on inductance, (a) quality factor, (b) value for different inner diameter.
c. Effect of Inner diameter

Figure 7 shows the simulation of results of the inductance and maximum quality factor variation versus frequency for different values of inner diameter (i.e. (60 µm, 70 µm and 80 µm). As shown in Figure 7(a), the inductance increases within the range of frequency and the highest increase is obtained with the highest inner diameter of 80 µm. However, the maximum quality factor decreases as the inner diameter increase. As shown in Figure 7(b), the highest maximum quality factor is obtained at 60 µm. This increase is related to the changes of the distance between opposite sides at the center of the spiral.

3.2. Comparison with state of the art work

Comparative studies based on the size, maximum quality factor, inductance is between previous works, and our design is summarized in Table 3. The values of the size of inductor, maximum quality factor and inductance indicated in table under our work are derived from the parametric analysis performed.

<table>
<thead>
<tr>
<th>Inductor design</th>
<th>Size</th>
<th>(Q_{\text{max}})</th>
<th>(L) (H)</th>
<th>Réf</th>
</tr>
</thead>
<tbody>
<tr>
<td>Square inductor</td>
<td>380*500(µm²)</td>
<td>25</td>
<td>26 (\times 10^{-9})</td>
<td>[29]</td>
</tr>
<tr>
<td>Hexagonal inductor</td>
<td>320*320(µm²)</td>
<td>53</td>
<td>24,4 (\times 10^{-9})</td>
<td>[30]</td>
</tr>
<tr>
<td>Circular inductor</td>
<td>300*300(µm²)</td>
<td>22</td>
<td>33,3 (\times 10^{-9})</td>
<td>[31]</td>
</tr>
<tr>
<td>Octogonal inductor</td>
<td>140*140(µm²)</td>
<td>12</td>
<td>75 (\times 10^{-9})</td>
<td>Our work</td>
</tr>
</tbody>
</table>

4. BUCK CONVERTER APPLICATION

A buck micro converter DC-DC depicted in Figure 8 is selected and PSIM software is used for its simulation. The values of the micro converter electrical characteristics are indicated in Table 4. The different technological parameters of the integrated inductor are calculated (Table 2) and replaced by classic inductor.

![Figure 8. Schematic diagram of Buck converter DC-DC](image)

<table>
<thead>
<tr>
<th>Electrical characteristics</th>
<th>Symbol</th>
<th>Value</th>
</tr>
</thead>
<tbody>
<tr>
<td>Input Voltage</td>
<td>(\text{Vin})</td>
<td>3 V</td>
</tr>
<tr>
<td>Output voltage</td>
<td>(\text{Vout})</td>
<td>1.2 V</td>
</tr>
<tr>
<td>Switching frequency of the converter</td>
<td>(f)</td>
<td>5 MHz</td>
</tr>
</tbody>
</table>

Figure 9 shows the waveform of the output voltage and current of the Buck converter with integrated spiral inductor. The output current simulated at the switching frequency of 5 MHz is shown in red color. As shown in figure 9, both the output current (red line) and output voltage (blue line) of the converter are constant. The output current and voltage are settled at about 0.4 A and 1.2 volts respectively. It can be noticed the input voltage of 3V of the converter is lowered to 1.2 V.
The most challenging issues encountered were the determination of the appropriate geometrical structure and suitable technological parameters of the spiral inductor. In this work, it was observed that the geometry of spiral inductor is an important design factor and it has a huge influence on the performance of RFIC (Radio Frequency Integrated Circuit). Moreover, it was also observed that the highest maximum quality factor of octagonal spiral inductor structures is obtained with low number of turns and low inner diameter. The simulation results of the DC-DC buck converter show that the desired value of the output voltage can be obtained.

In conclusion, it can be stated that the simulation results are very successful and demonstrate that the proposed structure of the spiral inductor is a very promising advance for the integration of buck converter.

REFERENCES


